FEE TRANSMITTAL

Electronic Version v08

Stylesheet Version v08.0

Title of Invention CHIP STRUCTURE WITH BUMPS AND A PROCESS FOR FABRICATING THE SAME

Application Number:

Attorney Docket Number:

Date:

First Named Applicant: Mr. Chao-Fu Weng

TOTAL FEE AUTHORIZED \$ 770

Patent fees are subject to annual revisions on or about October 1st of each year.

8012-US-PA-1

Filing as large entity

BASIC FILING FEE

Fee Description	Fee Code	Amount \$	Fee Paid \$			
Utility Filing Fee	1001	770	770			
Subtotal For Basic Filing Fees: \$ 770						

EXTRA CLAIM FEES

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$		
Total Claims: 14	0	1202	18	0		
Independent Claims : 3	0	1201	86	0		
Subtotal For Extra Claims Fees: \$ 0						

AUTHORIZED BILLING INFORMATION

The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Credit account number: 1007

Expiration Date (YYYYMMDD): 2005-12-31

Authorized name: YEH, WEN-HUNG

Billing address: 99999